Hi Fi 175W Class-D Audio Amp with Digital Inputs

Designed for: Not For Public Release

Assembly Variant: 001

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Hi Fi 175W Class-D Audio Amp with Digital Inputs

Assembly Note ZZ1
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Assembly Note ZZ2
These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
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